

**TRENCHSTOP™ IGBT6 with soft, fast recovery antiparallel Rapid diode**

**Features**

- $V_{CE} = 650\text{ V}$
- $I_C = 15\text{ A}$
- Very low  $V_{CE(sat)}$  1.5 V (typ.)
- Maximum junction temperature  $T_{vjmax} = 175^\circ\text{C}$
- Short circuit withstand time 3  $\mu\text{s}$
- Very tight parameter distribution
- High ruggedness, temperature stable behavior
- Low  $V_{CE(sat)}$  and positive temperature coefficient
- Low gate charge  $Q_G$
- Pb-free lead plating; RoHS compliant
- Very soft, fast recovery antiparallel Rapid diode
- Product spectrum and PSpice Models: <http://www.infineon.com/igbt/>

**Potential applications**

- General purpose drives (GPD)
- Air conditioning
- Other major home appliances
- Other small home appliances

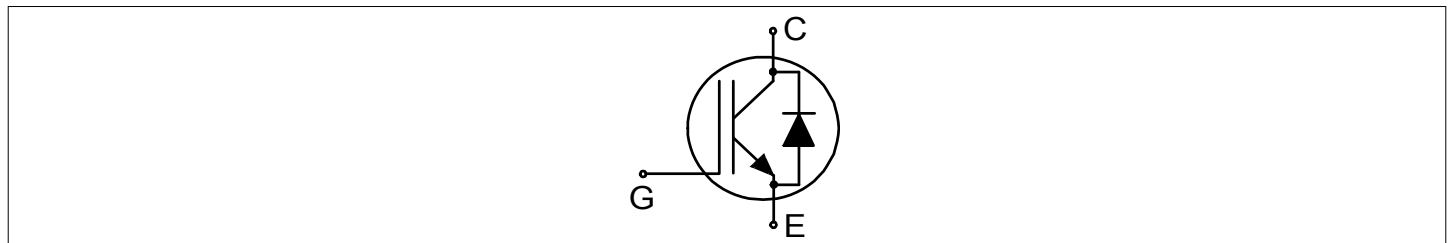
**Product validation**

- Qualified for industrial applications according to the relevant tests of JEDEC47/20/22

**Description**



- Lead-Free
- Green
- Halogen-Free
- RoHS



Type	Package	Marking
IKA15N65ET6	PG-TO220-3 FP	K15EET6

## Table of contents

	<b>Description</b> .....	1
	<b>Features</b> .....	1
	<b>Potential applications</b> .....	1
	<b>Product validation</b> .....	1
	<b>Table of contents</b> .....	2
<b>1</b>	<b>Package</b> .....	3
<b>2</b>	<b>IGBT</b> .....	3
<b>3</b>	<b>Diode</b> .....	5
<b>4</b>	<b>Characteristics diagrams</b> .....	7
<b>5</b>	<b>Package outlines</b> .....	14
<b>6</b>	<b>Testing conditions</b> .....	15
	<b>Revision history</b> .....	16
	<b>Disclaimer</b> .....	17

## 1 Package

**Table 1** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Isolation test voltage RMS	$V_{isol}$	$f = +50/+60$ Hz, $t = 1$ min			2500	V
Internal emitter inductance measured 5 mm (0.197 in) from case	$L_E$			7.0		nH
Storage temperature	$T_{stg}$		-55		150	°C
Soldering temperature		wave soldering 1.6mm (0.063in.) from case for 10s			260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	$M$				0.5	Nm
Thermal resistance, junction-ambient	$R_{th(j-a)}$				65	K/W

## 2 IGBT

**Table 2** Maximum rated values

Parameter	Symbol	Note or test condition	Values	Unit
Collector-emitter voltage	$V_{CE}$	$T_{vj} \geq 25$ °C	650	V
DC collector current, limited by $T_{vjmax}$ <sup>1)</sup>	$I_C$	$T_h = 25$ °C	34	A
		$T_h = 100$ °C	21	
Pulsed collector current, $t_p$ limited by $T_{vjmax}$	$I_{Cpuls}$		57.5	A
Turn-off safe operating area		$V_{CE} \leq 650$ V, $T_{vj} \leq 175$ °C	57.5	A
Gate-emitter voltage	$V_{GE}$		±20	V
Transient gate-emitter voltage	$V_{GE}$	$t_p \leq 10$ μs, $D < 0.010$	±30	V
Short-circuit withstand time	$t_{SC}$	$V_{CC} \leq 360$ V, $V_{GE} = 15$ V, Allowed number of short circuits < 1000, Time between short circuits $\geq 1.0$ s, $T_{vj} = 150$ °C	3	μs
Power dissipation	$P_{tot}$	$T_h = 25$ °C	35.3	W
		$T_h = 100$ °C	17.6	

1) Limited by maximum junction temperature. Applicable for TO220 standard package.

**Table 3** Characteristic values

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Collector-emitter breakdown voltage <sup>1)</sup>	$V_{BRCES}$	$I_C = 0.1 \text{ mA}, V_{GE} = 0 \text{ V}$	650			V
Collector-emitter saturation voltage	$V_{CEsat}$	$I_C = 11.5 \text{ A}, V_{GE} = 15 \text{ V}$	$T_{vj} = 25 \text{ °C}$	1.5	1.9	V
			$T_{vj} = 125 \text{ °C}$	1.65		
			$T_{vj} = 150 \text{ °C}$	1.75		
Gate-emitter threshold voltage	$V_{GEth}$	$I_C = 0.20 \text{ mA}, V_{CE} = V_{GE}$	4.8	5.6	6.4	V
Zero gate-voltage collector current	$I_{CES}$	$V_{GE} = 0 \text{ V}, V_{CE} = 650 \text{ V}$	$T_{vj} = 25 \text{ °C}$		30	$\mu\text{A}$
			$T_{vj} = 150 \text{ °C}$		450	
Gate-emitter leakage current	$I_{GES}$	$V_{CE} = 0 \text{ V}, V_{GE} = 20 \text{ V}$			100	nA
Transconductance	$g_{fs}$	$I_C = 11.5 \text{ A}, V_{CE} = 20 \text{ V}, T_{vj} \geq 25 \text{ °C}$		11.6		S
Short-circuit collector current	$I_{SC}$	$V_{CC} \leq 360 \text{ V}, V_{GE} = 15 \text{ V}, t_{SC} \leq 3 \mu\text{s}$ , Allowed number of short circuits < 1000 , Time between short circuits $\geq 1.0 \text{ s}$ , $T_{vj} = 150 \text{ °C}$		120		A
Input capacitance	$C_{ies}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1000 \text{ kHz}$		1020		pF
Output capacitance	$C_{oes}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1000 \text{ kHz}$		50		pF
Reverse transfer capacitance	$C_{res}$	$V_{CE} = 25 \text{ V}, V_{GE} = 0 \text{ V}, f = 1000 \text{ kHz}$		20		pF
Gate charge	$Q_G$	$I_C = 11.5 \text{ A}, V_{GE} = 15 \text{ V}$		37		nC
Turn-on delay time	$t_{don}$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 47.0 \Omega, R_{Goff} = 47.0 \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 150 \text{ pF}$	$T_{vj} = 25 \text{ °C}, I_C = 11.5 \text{ A}$	30		ns
			$T_{vj} = 150 \text{ °C}, I_C = 11.5 \text{ A}$	27		
Rise time (inductive load)	$t_r$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 47.0 \Omega, R_{Goff} = 47.0 \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 150 \text{ pF}$	$T_{vj} = 25 \text{ °C}, I_C = 11.5 \text{ A}$	22		ns
			$T_{vj} = 150 \text{ °C}, I_C = 11.5 \text{ A}$	23		
Turn-off delay time	$t_{doff}$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 47.0 \Omega, R_{Goff} = 47.0 \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 150 \text{ pF}$	$T_{vj} = 25 \text{ °C}, I_C = 11.5 \text{ A}$	117		ns
			$T_{vj} = 150 \text{ °C}, I_C = 11.5 \text{ A}$	135		
Fall time (inductive load)	$t_f$	$V_{CE} = 400 \text{ V}, V_{GE} = 15 \text{ V}, R_{Gon} = 47.0 \Omega, R_{Goff} = 47.0 \Omega, L_\sigma = 30 \text{ nH}, C_\sigma = 150 \text{ pF}$	$T_{vj} = 25 \text{ °C}, I_C = 11.5 \text{ A}$	42		ns
			$T_{vj} = 150 \text{ °C}, I_C = 11.5 \text{ A}$	67		

(table continues...)

**Table 3 (continued) Characteristic values**

Parameter	Symbol	Note or test condition	Values			Unit
			Min.	Typ.	Max.	
Turn-on energy	$E_{on}$	$V_{CE} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 47.0\ \Omega,$ $R_{Goff} = 47.0\ \Omega,$ $L_{\sigma} = 30\text{ nH}, C_{\sigma} = 150\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$	0.23		mJ
			$T_{vj} = 150\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$	0.32		
Turn-off energy	$E_{off}$	$V_{CE} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 47.0\ \Omega,$ $R_{Goff} = 47.0\ \Omega,$ $L_{\sigma} = 30\text{ nH}, C_{\sigma} = 150\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$	0.11		mJ
			$T_{vj} = 150\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$	0.18		
Total switching energy	$E_{ts}$	$V_{CE} = 400\text{ V}, V_{GE} = 15\text{ V},$ $R_{Gon} = 47.0\ \Omega,$ $R_{Goff} = 47.0\ \Omega,$ $L_{\sigma} = 30\text{ nH}, C_{\sigma} = 150\text{ pF}$	$T_{vj} = 25\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$	0.34		mJ
			$T_{vj} = 150\text{ }^{\circ}\text{C},$ $I_C = 11.5\text{ A}$	0.5		
IGBT thermal resistance, junction to case	$R_{thjc}$				4.3	K/W
IGBT thermal resistance, junction to heat sink	$R_{thjh}$				4.30	K/W
Operating junction temperature	$T_{vj}$		-40		175	$^{\circ}\text{C}$

1) Measured with filter network.

Note: Electrical Characteristic, at  $T_{vj} = 25\text{ }^{\circ}\text{C}$ , unless otherwise specified.

### 3 Diode

**Table 4 Maximum rated values**

Parameter	Symbol	Note or test condition	Values	Unit	
Repetitive peak reverse voltage	$V_{RRM}$	$T_{vj} \geq 25\text{ }^{\circ}\text{C}$	650	V	
Diode forward current, limited by $T_{vjmax}$ <sup>1)</sup>	$I_F$		$T_h = 25\text{ }^{\circ}\text{C}$	34	A
			$T_h = 100\text{ }^{\circ}\text{C}$	21	
Diode pulsed current, limited by $T_{vjmax}$	$I_{Fpuls}$		57.5	A	

1) Limited by maximum junction temperature. Applicable for TO220 standard package.

**Table 5** Characteristic values

Parameter	Symbol	Note or test condition		Values			Unit
				Min.	Typ.	Max.	
Diode forward voltage	$V_F$	$I_F = 11.5 \text{ A}$	$T_{vj} = 25 \text{ °C}$		1.5	1.95	V
					1.48		
					1.43		
Reverse leakage current	$I_R$	$V_R = 650 \text{ V}$	$T_{vj} = 25 \text{ °C}$			30	$\mu\text{A}$
					450		
Diode reverse recovery time	$t_{rr}$	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$ , $I_F = 11.5 \text{ A}$ , $-di_F/dt = 400 \text{ A}/\mu\text{s}$		69		ns
					113		
Diode reverse recovery charge	$Q_{rr}$	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$ , $I_F = 11.5 \text{ A}$ , $-di_F/dt = 400 \text{ A}/\mu\text{s}$		0.210		$\mu\text{C}$
					0.500		
Diode peak reverse recovery current	$I_{rrm}$	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$ , $I_F = 11.5 \text{ A}$ , $-di_F/dt = 400 \text{ A}/\mu\text{s}$		5.1		A
					8.0		
Diode peak rate of fall of reverse recovery current	$di_{rr}/dt$	$V_R = 400 \text{ V}$	$T_{vj} = 25 \text{ °C}$ , $I_F = 11.5 \text{ A}$ , $-di_F/dt = 400 \text{ A}/\mu\text{s}$		-265		$\text{A}/\mu\text{s}$
					-228		
Diode thermal resistance, junction to case	$R_{thjc}$					5.8	K/W
Diode thermal resistance, junction to heat sink	$R_{thjh}$					5.80	K/W
Operating junction temperature	$T_{vj}$			-40		175	$^{\circ}\text{C}$

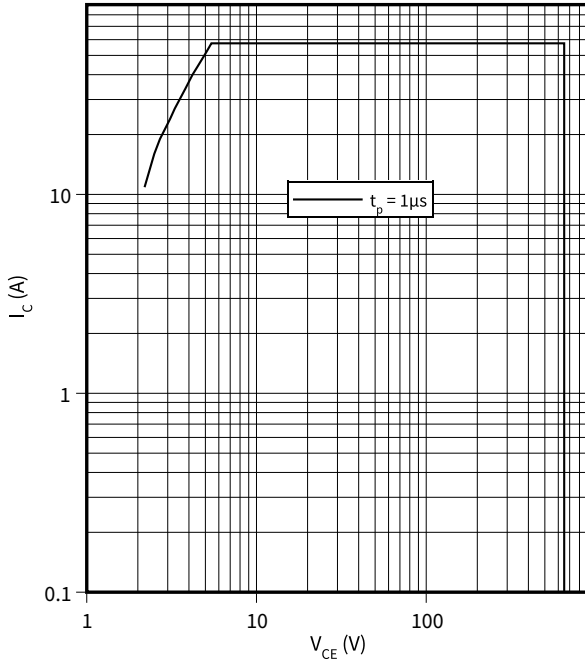
*Note: For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.*

## 4 Characteristics diagrams

### Forward bias safe operating area, IGBT

$$I_C = f(V_{CE})$$

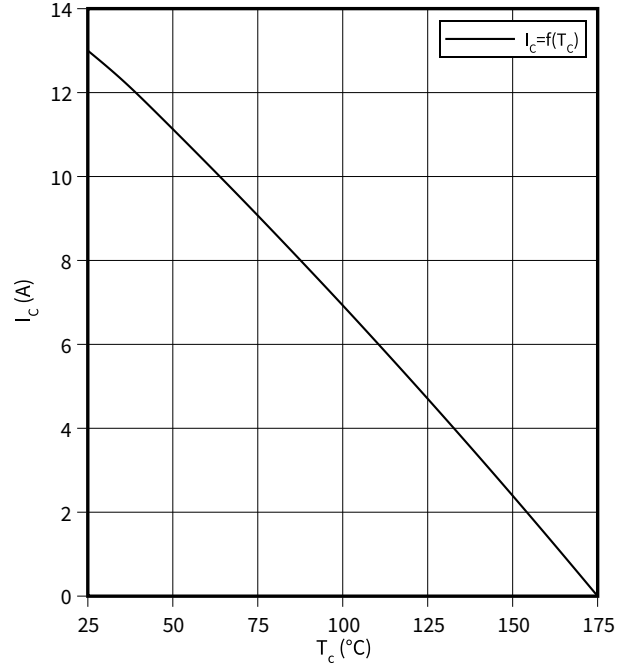
$D = 0$ ,  $T_{vj} \geq 25\text{ °C}$ ,  $V_{GE} \geq 15\text{ V}$ ,  $T_h = 25\text{ °C}$



### Collector current as a function of case temperature, IGBT

$$I_C = f(T_c)$$

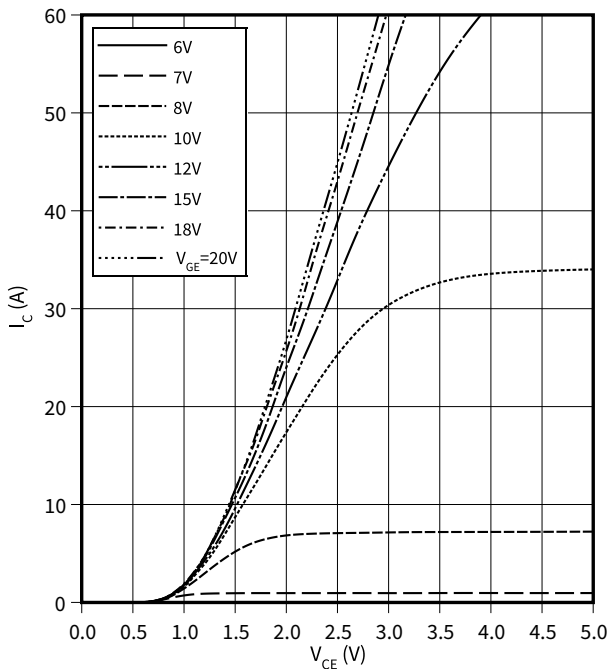
$T_{vj} \leq 175\text{ °C}$ ,  $V_{GE} \geq 15\text{ V}$



### Typical output characteristic, IGBT

$$I_C = f(V_{CE})$$

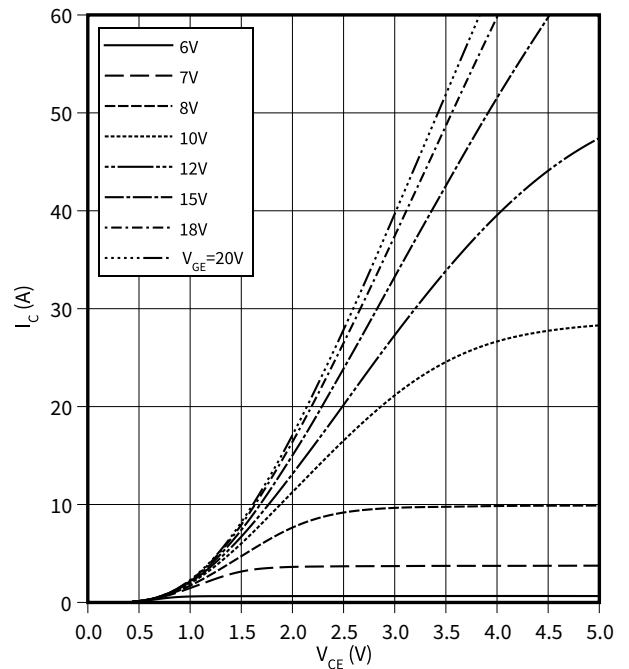
$T_{vj} = 25\text{ °C}$



### Typical output characteristic, IGBT

$$I_C = f(V_{CE})$$

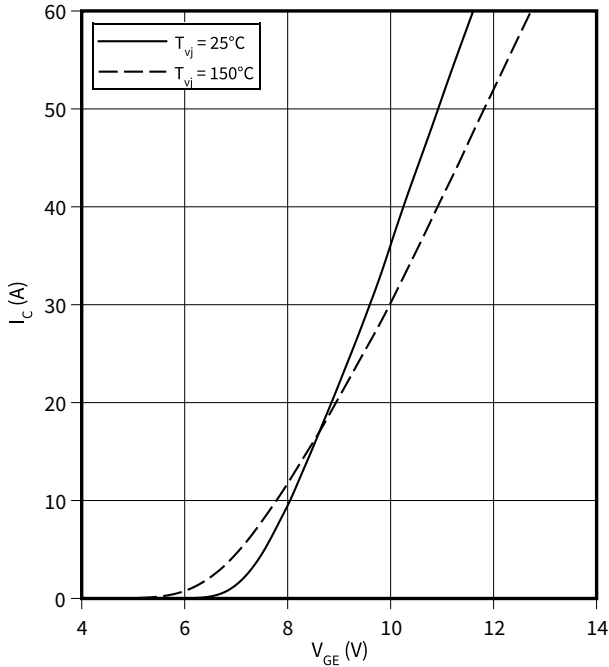
$T_{vj} = 150\text{ °C}$



4 Characteristics diagrams

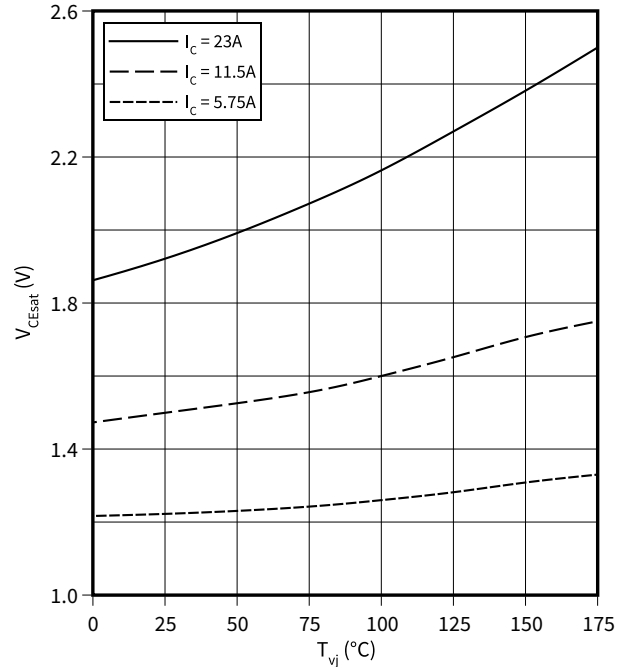
**Typical transfer characteristic, IGBT**

$I_C = f(V_{GE})$   
 $V_{CE} = 50\text{ V}$



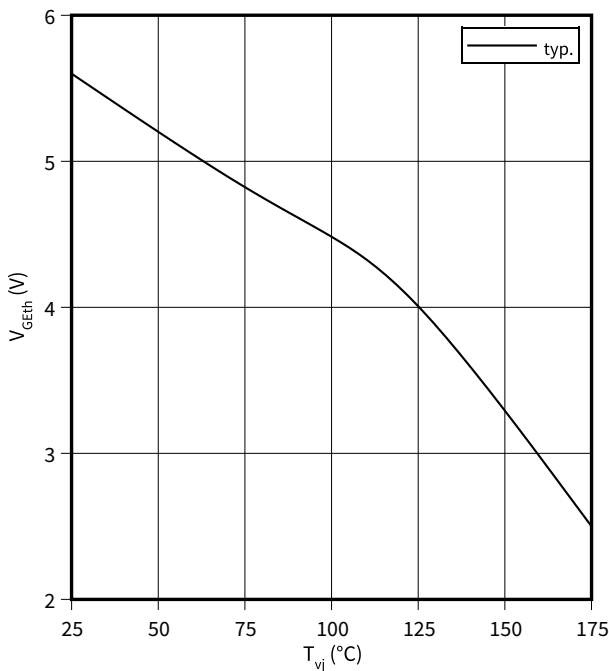
**Typical collector-emitter saturation voltage as a function of junction temperature, IGBT**

$V_{CEsat} = f(T_{vj})$   
 $V_{GE} = 15\text{ V}$



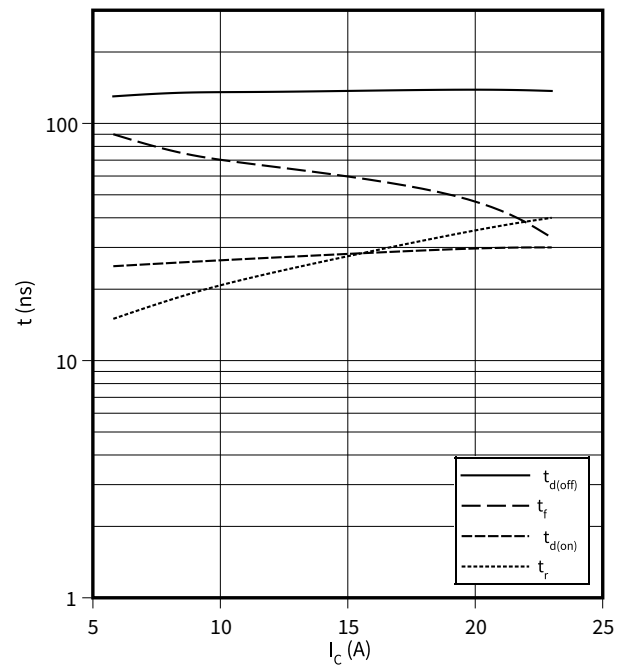
**Gate-emitter threshold voltage as a function of junction temperature, IGBT**

$V_{GEth} = f(T_{vj})$   
 $I_C = 0.20\text{ mA}$



**Typical switching times as a function of collector current, IGBT**

$t = f(I_C)$   
 $V_{CE} = 400\text{ V}, T_{vj} = 150^\circ\text{C}, V_{GE} = 0/15\text{ V}, R_G = 47\ \Omega$

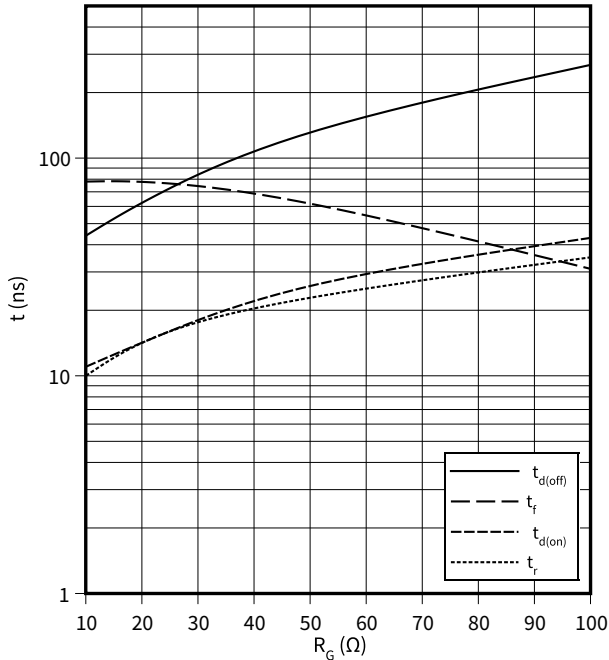


4 Characteristics diagrams

**Typical switching times as a function of gate resistor, IGBT**

$t = f(R_G)$

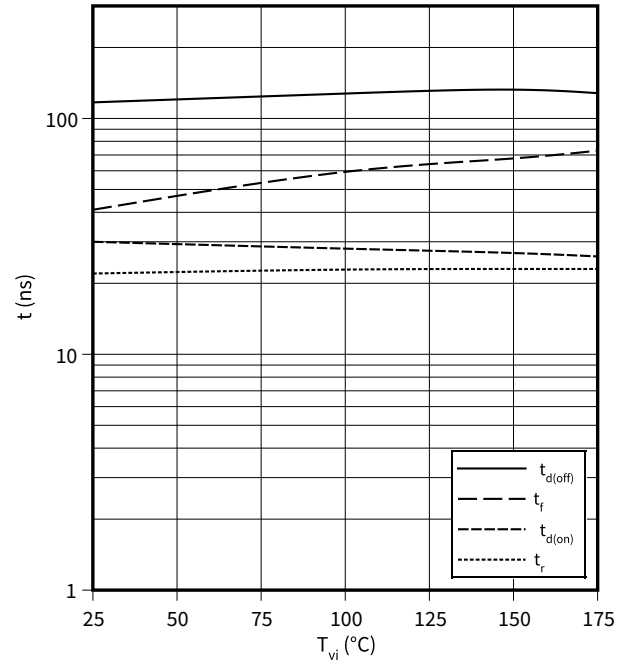
$I_C = 11.5 \text{ A}$ ,  $V_{CE} = 400 \text{ V}$ ,  $T_{vj} = 150 \text{ °C}$ ,  $V_{GE} = 0/15 \text{ V}$



**Typical switching times as a function of junction temperature, IGBT**

$t = f(T_{vj})$

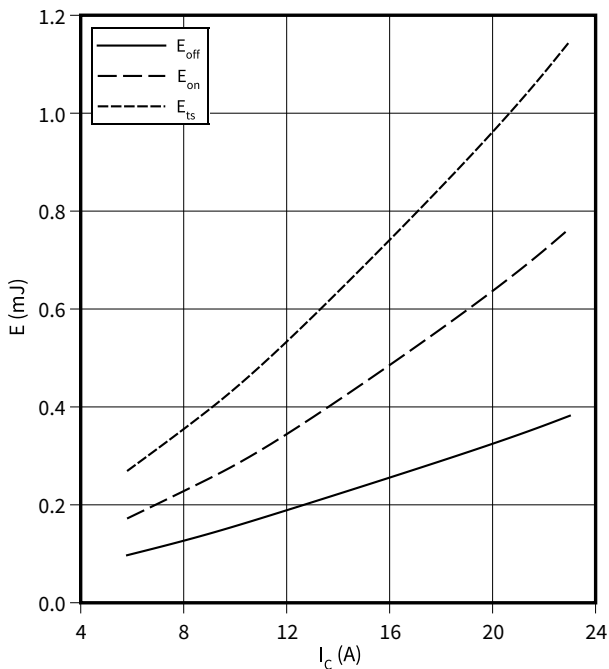
$I_C = 11.5 \text{ A}$ ,  $V_{CE} = 400 \text{ V}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 47 \text{ } \Omega$



**Typical switching energy losses as a function of collector current, IGBT**

$E = f(I_C)$

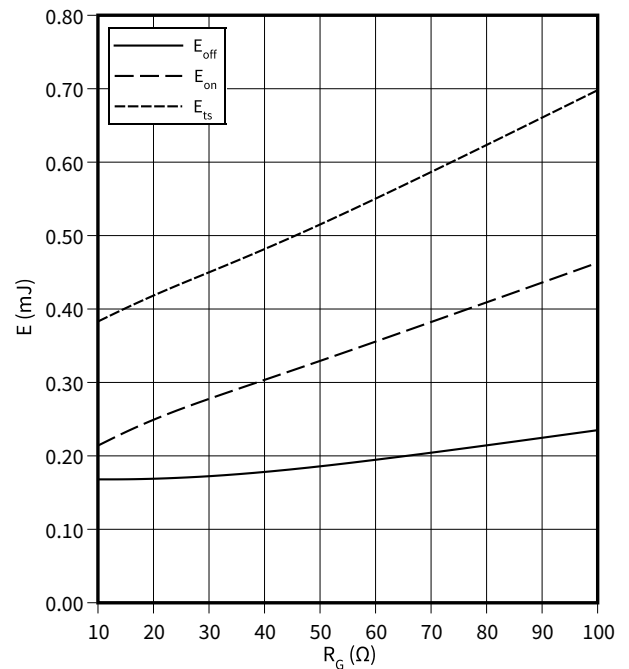
$V_{CE} = 400 \text{ V}$ ,  $T_{vj} = 150 \text{ °C}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 47 \text{ } \Omega$



**Typical switching energy losses as a function of gate resistor, IGBT**

$E = f(R_G)$

$I_C = 11.5 \text{ A}$ ,  $V_{CE} = 400 \text{ V}$ ,  $T_{vj} = 150 \text{ °C}$ ,  $V_{GE} = 0/15 \text{ V}$

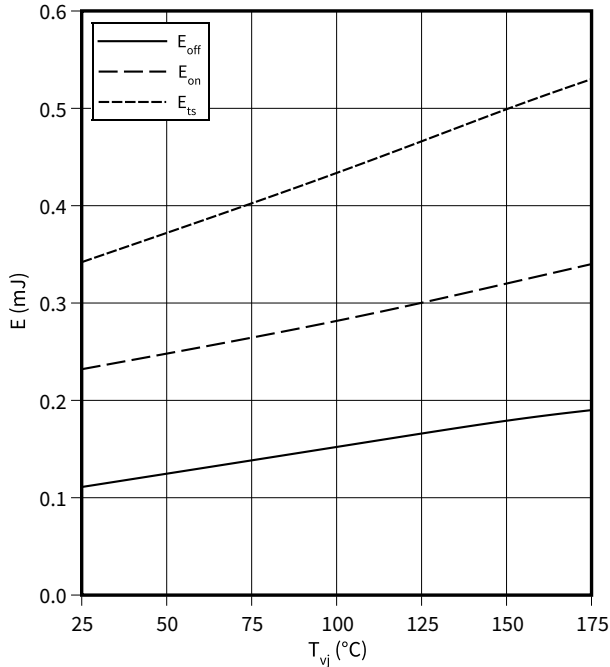


4 Characteristics diagrams

**Typical switching energy losses as a function of junction temperature, IGBT**

$E = f(T_{vj})$

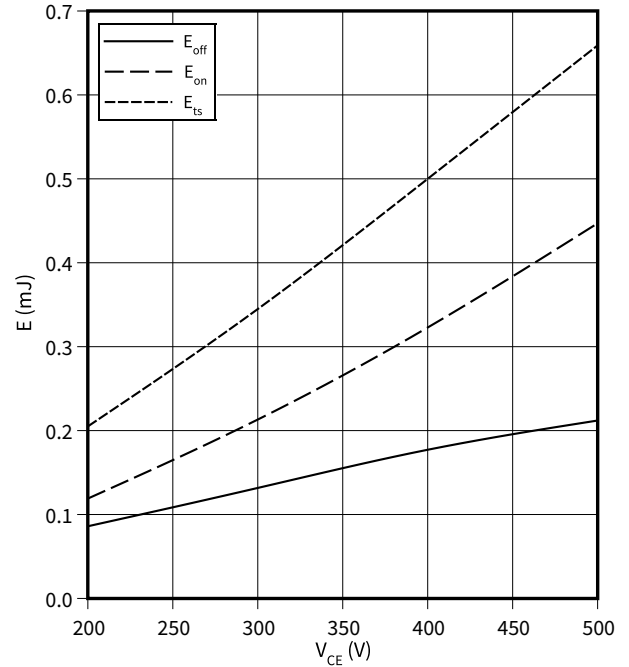
$I_C = 11.5 \text{ A}$ ,  $V_{CE} = 400 \text{ V}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $R_G = 47 \Omega$



**Typical switching energy losses as a function of collector emitter voltage, IGBT**

$E = f(V_{CE})$

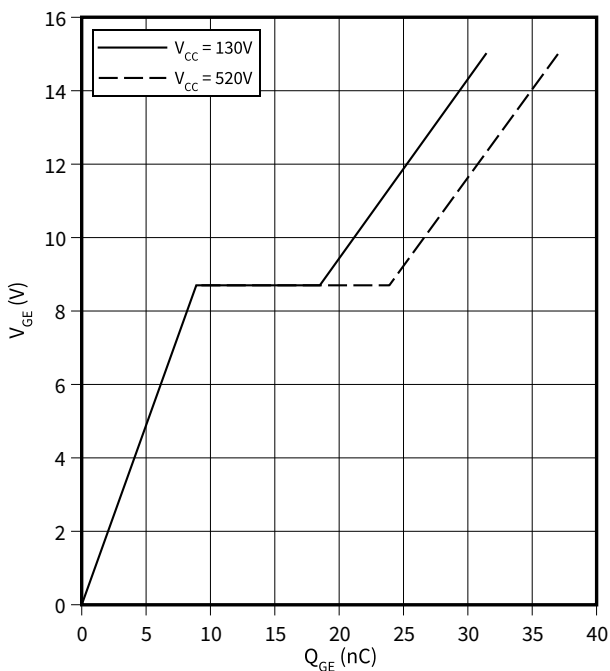
$I_C = 11.5 \text{ A}$ ,  $V_{GE} = 0/15 \text{ V}$ ,  $T_{vj} = 150 \text{ °C}$ ,  $R_G = 47 \Omega$



**Typical gate charge, IGBT**

$V_{GE} = f(Q_{GE})$

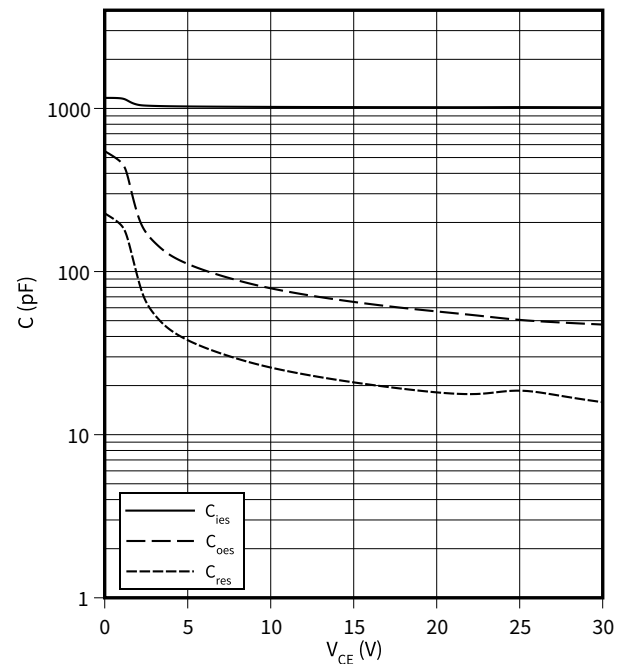
$I_C = 11.5 \text{ A}$



**Typical capacitance as a function of collector-emitter voltage, IGBT**

$C = f(V_{CE})$

$f = 1000 \text{ kHz}$ ,  $V_{GE} = 0 \text{ V}$



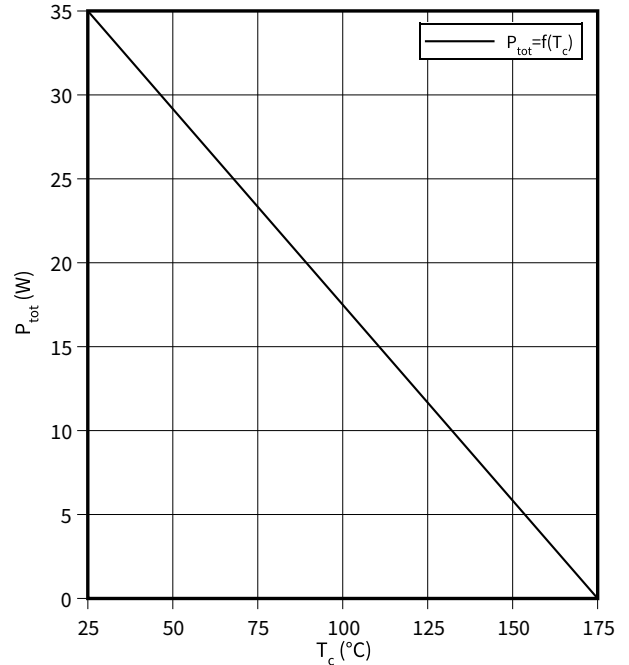
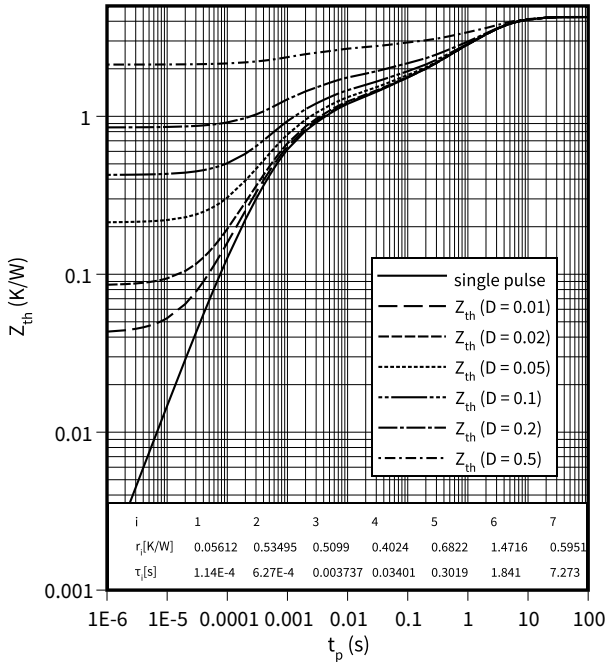
4 Characteristics diagrams

**IGBT transient thermal impedance, IGBT**

$Z_{th} = f(t_p)$   
 $D = t_p/T$

**Power dissipation as a function of case temperature, IGBT**

$P_{tot} = f(T_c)$   
 $T_{vj} \leq 175\text{ °C}$

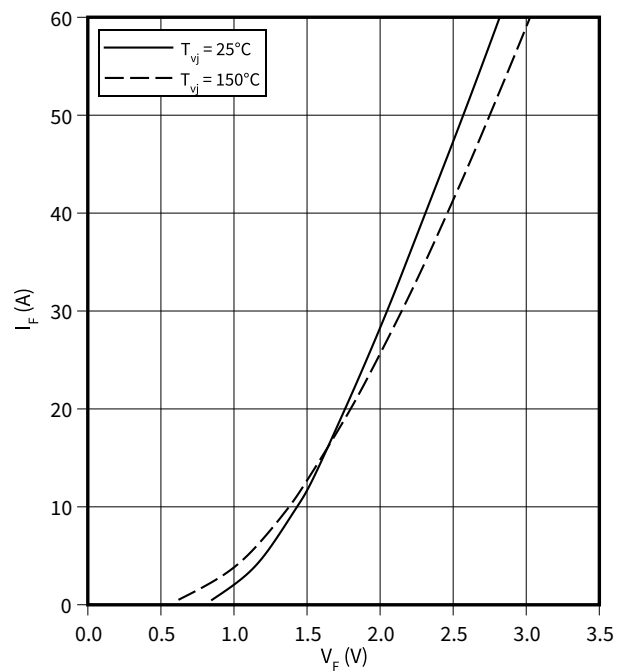
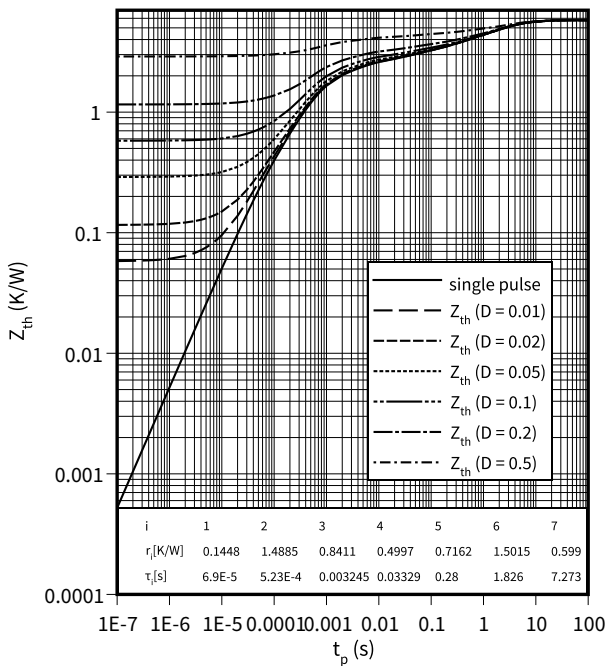


**Diode transient thermal impedance as a function of pulse width, Diode**

$Z_{th} = f(t_p)$   
 $D = t_p/T$

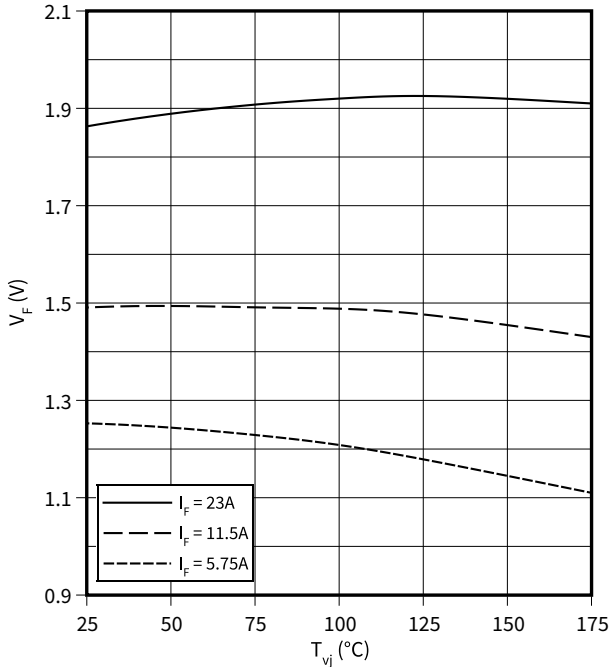
**Typical diode forward current as a function of forward voltage, Diode**

$I_F = f(V_F)$



**Typical diode forward voltage as a function of junction temperature, Diode**

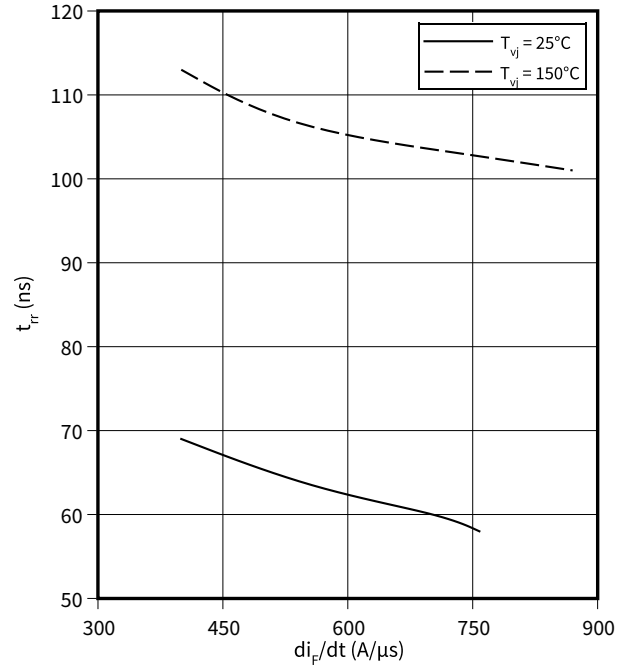
$V_F = f(T_{vj})$



**Typical reverse recovery time as a function of diode current slope, Diode**

$t_{rr} = f(di_F/dt)$

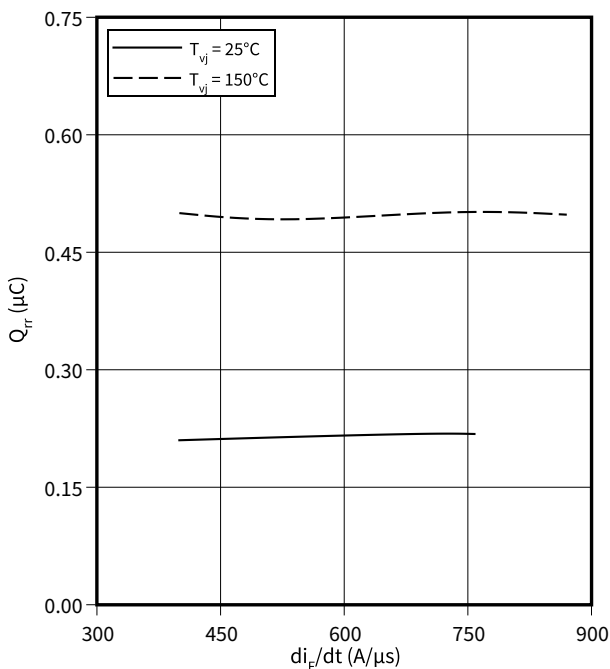
$V_R = 400 V, I_F = 11.5 A$



**Typical reverse recovery charge as a function of diode current slope, Diode**

$Q_{rr} = f(di_F/dt)$

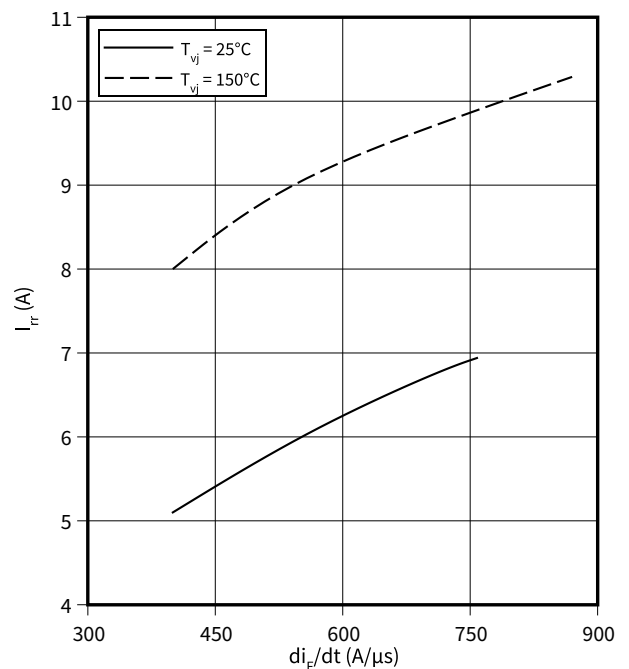
$V_R = 400 V, I_F = 11.5 A$



**Typical reverse recovery current as a function of diode current slope, Diode**

$I_{rr} = f(di_F/dt)$

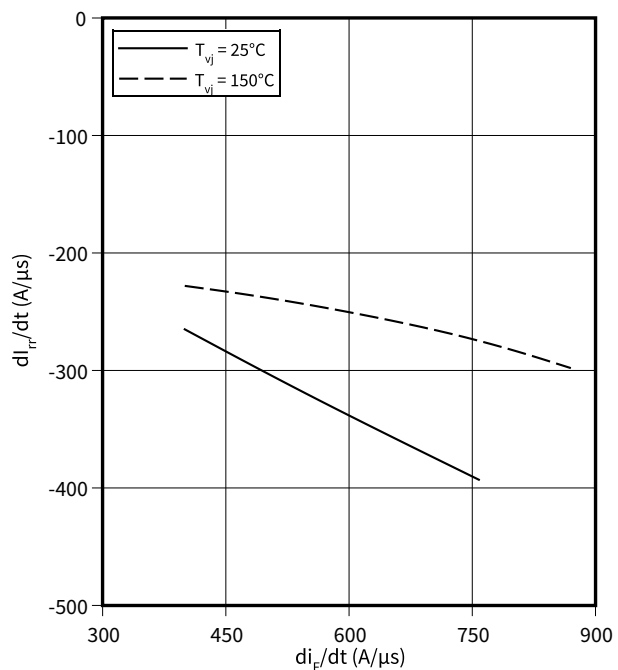
$V_R = 400 V, I_F = 11.5 A$



**Typical diode peak rate of fall of reverse recovery current as a function of diode current slope, Diode**

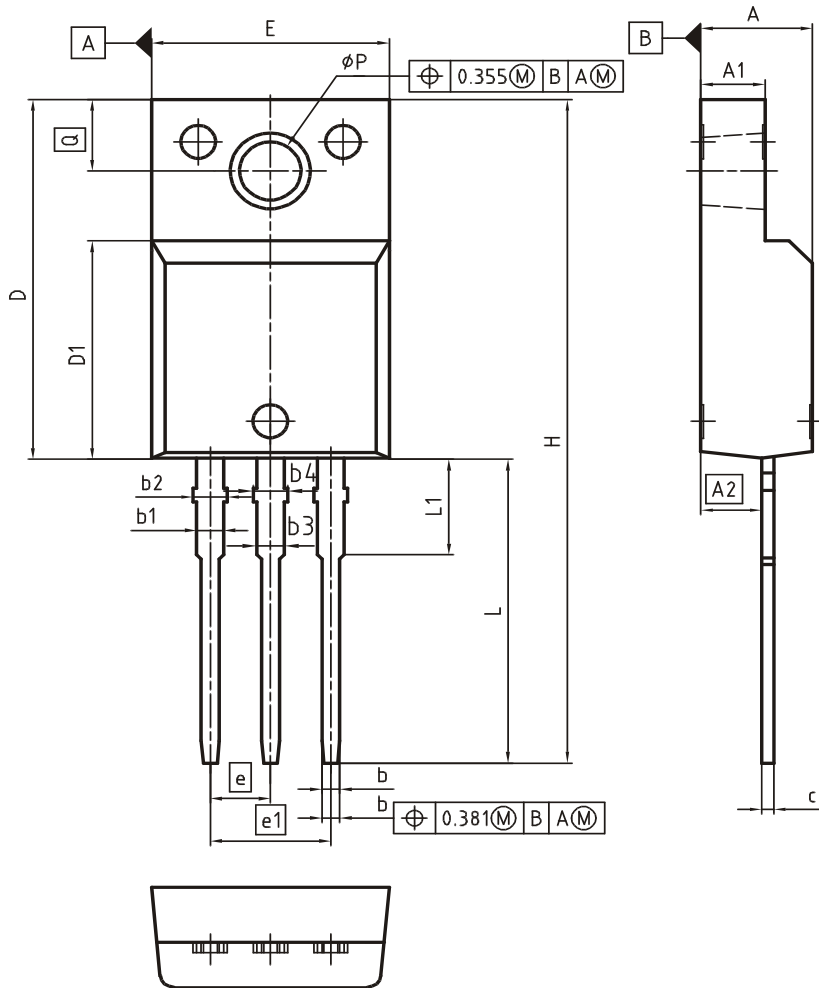
$$di_{rr}/dt = f(di_F/dt)$$

$V_R = 400\text{ V}$ ,  $I_F = 11.5\text{ A}$



5 Package outlines

Package Drawing PG-TO220-3-FP



DIM	MILLIMETERS		INCHES	
	MIN	MAX	MIN	MAX
A	4.55	4.85	0.179	0.191
A1	2.55	2.85	0.100	0.112
A2	2.42	2.72	0.095	0.107
b	0.65	0.85	0.026	0.033
b1	0.95	1.33	0.037	0.052
b2	0.95	1.51	0.037	0.059
b3	0.65	1.33	0.026	0.052
b4	0.65	1.51	0.026	0.059
c	0.40	0.63	0.016	0.025
D	15.85	16.15	0.624	0.636
D1	9.53	9.83	0.375	0.387
E	10.35	10.65	0.407	0.419
e	2.54		0.100	
e1	5.08		0.200	
N	3		3	
H	29.45	29.75	1.159	1.171
L	13.45	13.75	0.530	0.541
L1	3.15	3.45	0.124	0.136
øP	2.95	3.20	0.116	0.126
Q	3.15	3.50	0.124	0.138

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Figure 1

## 6 Testing conditions

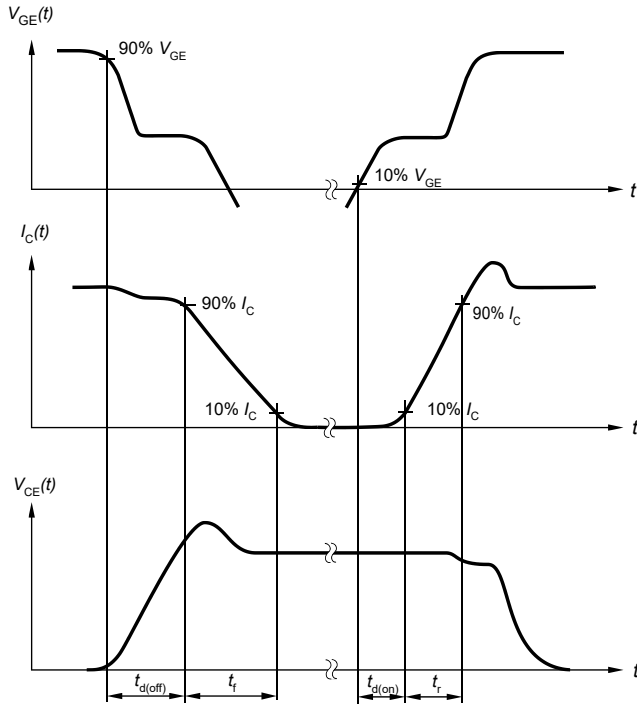


Figure A. Definition of switching times

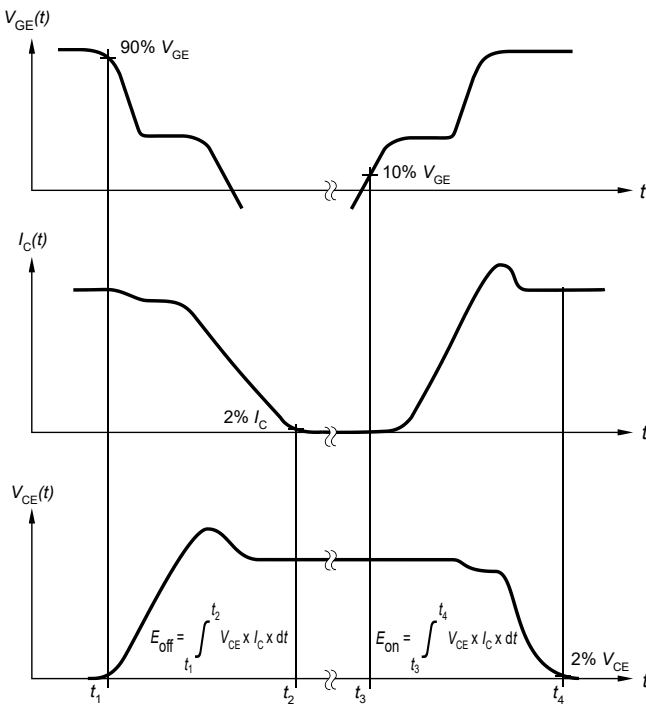


Figure B. Definition of switching losses

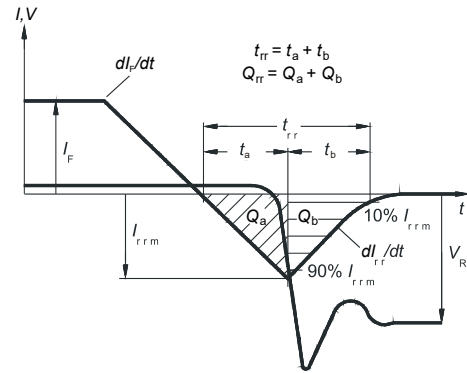


Figure C. Definition of diode switching characteristics

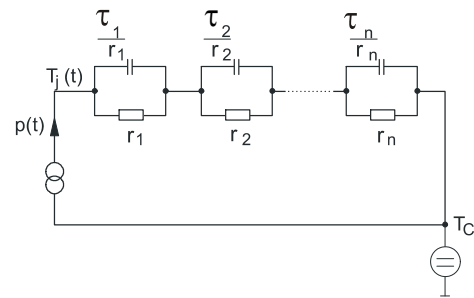


Figure D. Thermal equivalent circuit

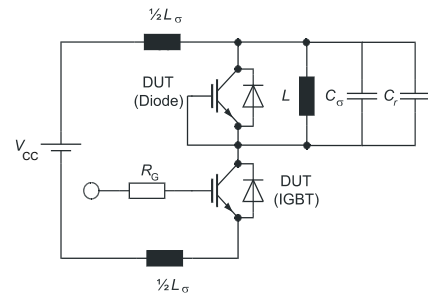


Figure E. Dynamic test circuit  
Parasitic inductance  $L_{\sigma}$ ,  
parasitic capacitor  $C_{\sigma}$ ,  
relief capacitor  $C_r$ ,  
(only for ZVT switching)

Figure 2

## Revision history

Document revision	Date of release	Description of changes
V2.1	2017-09-11	Final Datasheet
V2.2	2017-11-30	New Gfs Value at VCE=20V
V2.3	2019-09-13	Change of Rth/Zth values and maximum DC ratings
1.10	2021-10-18	Change of unit in thermal impedance figures

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